

# APPROVAL SHEET

MULTILAYER CERAMIC CAPACITORS

High Q / Low ESR Series (HH)

0201 to 0805 Sizes

**NP0** Dielectric

Halogen Free & RoHS Compliance

\*Contents in this sheet are subject to change without prior notice.



Approval Sheet

## 1. INTRODUCTION

MLCC consists of a conducting material and electrodes. To manufacture a chip-type SMT and achieve miniaturization, high density and high efficiency, ceramic condensers are used.

WTC HH series MLCC is used at high frequencies generally have a small temperature coefficient of capacitance, typical within the ±30ppm/°C required for NP0 (C0G) classification and have excellent conductivity internal electrode. Thus, WTC HH series MLCC will be with the feature of low ESR and high Q characteristics.

# 2. FEATURES

- a. High Q and low ESR performance at high frequency.
- b. Quality improvement of telephone calls for low power loss and better performance.

## 3. APPLICATIONS

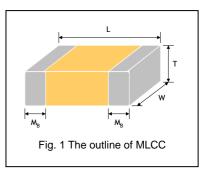
- a. Mobile telecommunication: Mobile phone, WLAN.
- b. RF module: Power amplifier, VCO.
- c. Tuners.

## 4. HOW TO ORDER

<u>HH</u>	<u>15</u>	<u>N</u>	<u>100</u>	<u>G</u>	<u>500</u>	<u>C</u>	I
Series	<u>Size</u>	Dielectric	Capacitance	Tolerance	Rated voltage	Termination	<u>Packaging</u>
<b>HH</b> =High Q/ Low ESR	<b>03</b> =0201 (0603) <b>15</b> =0402 (1005) <b>18</b> =0603 (1608) <b>21</b> =0805 (2012)	N=NP0 (COG)	Two significant digits followed by no. of zeros. And R is in place of decimal point.  PASSIVE SY: eg.: R47=0.47pF 0R5=0.5pF 1R0=1.0pF 100=10x10° =10pF	A=±0.05pF B=±0.1pF C=±0.25pF D=±0.5pF F=±1% G=±2% J=±5%	Two significant digits followed by no. of zeros. And R is in place of decimal point.  100=10 VDC 160=16 VDC 250=25 VDC 500=50 VDC 101=100 VDC 201=200 VDC 251=250 VDC 501=500 VDC 631=630 VDC	<b>C</b> =Cu/Ni/Sn	T=7" reeled G=13" reeled

# **5. EXTERNAL DIMENSIONS**

Size Inch (mm)	L (mm)	W (mm)	T (mm)/Sym	bol	Remark	M <sub>B</sub> (mm)	
0201 (0603)	0.6±0.03	0.3±0.03	0.3±0.03	L	#	0.15±0.05	
0402 (1005)	1.00±0.05	0.50±0.05	0.50±0.05	N	#	0.25 +0.05/-0.10	
	1.60±0.10	0.80±0.10	0.80±0.07	s			
0603 (1608)	1.60 +0.15/-0.10	0.80 +0.15/-0.10	0.80 +0.15/-0.10	х		0.40±0.15	
			0.60±0.10	А			
0805 (2012)	2.00±0.15	1.25±0.10	0.80±0.10	В		0.50±0.20	
			1.25±0.10	D	#		



# 6. GENERAL ELECTRICAL DATA

Dielectric	NPO /
Size	0201, 0402, 0603, 0805
Capacitance*	0.1pF to 3300pF
	Cap≤5pF <sup>#1</sup> : A (±0.05pF), B (±0.1pF), C (±0.25pF)
Capacitance tolerance	5pF <cap<10pf: (±0.25pf),="" (±0.5pf)<="" c="" d="" td=""></cap<10pf:>
	Cap≥10pF: F (±1%), G (±2%), J (±5%)
Rated voltage (WVDC)	10V, 16V, 25V, 50V, 100V, 200V, 250V, 500V, 630V
0.*	Cap<30pF: Q≥400+20C
Q*	Cap≥30pF: Q≥1000
Insulation resistance at Ur	≥10GΩ or RxC≥100Ω-F whichever is smaller.
Operating temperature	-55 to +125℃//
Capacitance change	±30ppm
Termination	Ni/Sn (lead-free termination)

<sup>#1:</sup> NP0, 0.1pF product only provide B tolerance

# 7. PACKAGING DIMENSION AND QUANTITY

Size	Thickness (mm)/Sym	Thickness (mm)/Symbol -			Plastic tape		
Size	mickiess (iiiii)/3yiii	7" reel	13" reel	7" reel	13" reel		
0201	0.30±0.03	L	15,000	70,000	-	-	
0402	0.50±0.05	N	10,000	50,000	-	-	
0000	0.80±0.07	S	4.000	45.000			
0603	0.80 +0.15/-0.10	Х	4,000	15,000	-	-	
	0.60±0.10	А	4.000	45.000			
0805	0.80±0.10	В	4,000	15,000	-	-	
	1.25±0.10	D	-	-	3,000	10,000	

Unit: pieces

<sup>#</sup> Reflow soldering only is recommended.

<sup>\*</sup> Measured at the conditions of 25℃ ambient temper ature and 30~70% related humidity.

Apply 1.0±0.2Vrms, 1.0MHz±10% for Cap≤1000pF and 1.0±0.2Vrms, 1.0kHz±10% for Cap>1000pF.



Approval Sheet

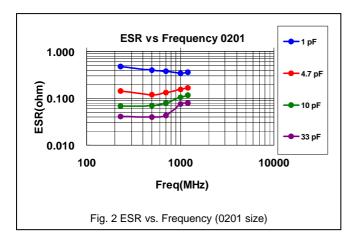
# **8. CAPACITANCE RANGE**

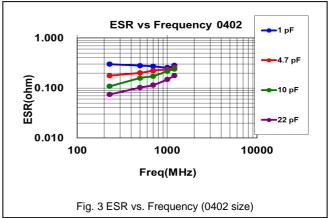
	DIELECTRIC										NP0									
	SIZE		02	01			04	02				0603					08	05		
	Rated Voltage	10	16	25	50	16	25	50	100	16	25	50	100	200	50	100	200	250	500	630
	0.1pF (0R1)					Ν	N	N	N											
	0.2pF (0R2)					Ν	N	N	N											
	0.3pF (0R3)	L	L	L	L	Ν	N	N	N											
	0.4pF (0R4)	L	L	L	L	N	N	N	N											
	0.5pF (0R5)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В				
	0.6pF (0R6)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В				
	0.7pF (0R7)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В				
	0.8pF (0R8)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В				
	0.9pF (0R9)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В				
	1.0pF (1R0)	L	L	L	L	Ν	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	1.2pF (1R2)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	1.5pF (1R5)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	1.8pF (1R8)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	2.2pF (2R2)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	2.7pF (2R7)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	3.3pF (3R3)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	3.9pF (3R9)	L	L	L	L	N	N	N	N	S	S	S	S	S	В	В	В	В	В	В
	4.7pF (4R7)	L	L	L	L	N	N	N/	N	S/-	S	S	S	S	В	В	В	В	В	В
	5.6pF (5R6)	L	L	L	L	N	N	N	N	S\(\)	S	S	S	S	В	В	В	В	В	В
	6.8pF (6R8)	L	L	L	L	N	N	N	$\Pi N_{A}$	S	S	S	S	S	В	В	В	В	В	В
	8.2pF (8R2)	L	L	L	L/\	N.	N	N.	$\geq$ N $\sim$	J S	S	\$	S	S	В	В	В	В	В	В
	10pF (100)	L	L	L	KW	N	N	N	N	S	/s	S	S	S	В	В	В	В	В	В
	12pF (120)	L	L	L	12/4	/ N	N	N	N	S	S	S	S		В	В	В	В	В	В
4	15pF (150)	L	L	L	L/	N//	N	N	N	S	S	S	S		В	В	В	В	В	В
Capacitance	18pF (180)	L	L	L	L	N	N	N	N	S	S	S	S		В	В	В	В	В	В
ita	22pF (220)	L	L	L	L	N	N	N	N	S	S	S	S		В	В	В	В	В	В
bac	27pF (270)	L	L	L	3	N	N.	Ñ	N	S	S	S	S		В	В	В	В	В	В
ပ္မ	33pF (330)	L	L	L	豸	N	N	N	N	S	S	Cs i	S		В	В	В	В	В	В
	39pF (390)				0	N	N	N	N	S	S	S	S		В	В	В	В	В	В
	47pF (470)				17	oN ∕	N	N	N	S	S	S	S		В	В	В	В	В	В
	56pF (560)					N	N)	N	N	S	S	S	S		В	В	В	В	В	В
	68pF (680)					N	N	/N C	N 9	S	S	S	S		В	В	В	В	В	В
	82pF (820)					N	/N/	N	N	SIT	)  S	S	S		В	В	В	В	В	В
_	100pF (101)					N	N"	N.	NK	SIN	S	S	S		В	В	В	В	В	В
	120pF (121)					N	N	N	N	S	S	S	S		D	D	D	D	D	D
	150pF (151)					N	N	N	N	S	S	S	S		D	D	D	D	D	D
	180pF (181)					N	N	N	N	S	S	S	S				D	D	D	D
	220pF (221)					N	N	N	N	S	S	S	S				D	D	D	D
	270pF (271)					N	N	N		S	S	S	S				D	D	D	D
	330pF (331)					N	N	N		S	S	S	S				D	D	D	D
	390pF (391)					N	N	N		S	S	S	S				D	D	D	D
	470pF (471)					N	N	N		S	S	S	S		<u> </u>					
	560pF (561)									S	S	S	S							-
	680pF (681)									S	S	S	S							-
	820pF (821)										S				<u> </u> 					
	1,000pF (102)									S	S	S	S							
	1,200pF (122)									X	X	X			<u> </u>					
	1,500pF (152)									X	X	X								-
	1,800pF (182)									X	X	X								-
	2,200pF (222)									X	X	X			<u> </u>					-
	2,700pF (272)									X	X	X			<u> </u>					
	3,300pF (332)									Χ	X	X								

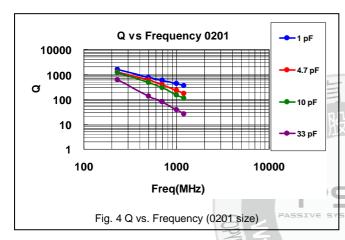
<sup>1.</sup> The letter in cell is expressed the symbol of product thickness.

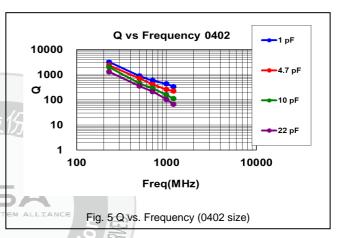
<sup>2.</sup> For more information about products with special capacitance or other data, please contact WTC local representative.

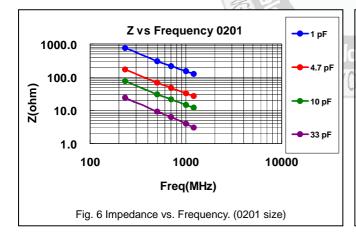
# 9. ELECTRICAL CHARACTERISTICS

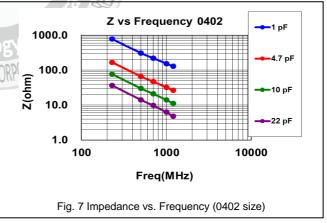


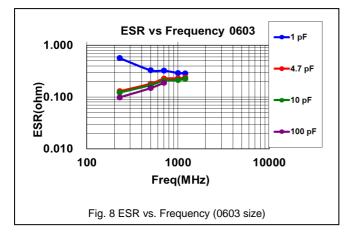


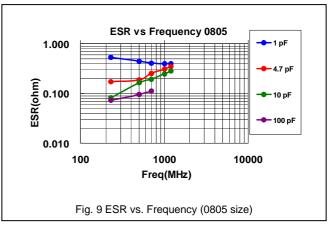


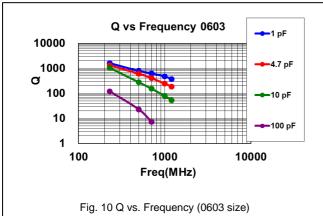


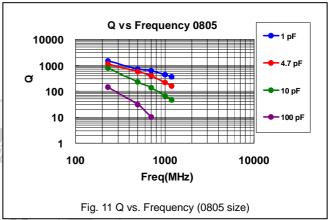


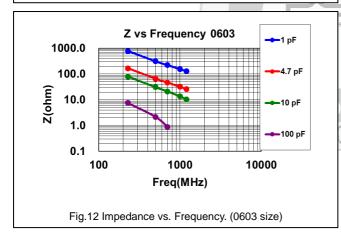


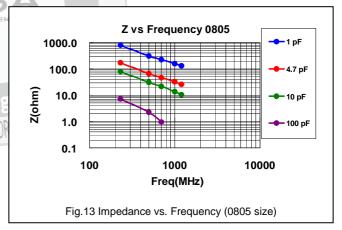


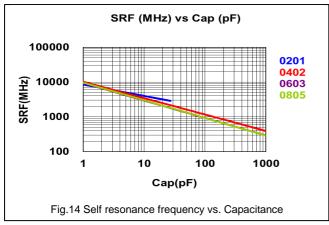














# 10. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Conditions	Requirements
1.	Visual and		* No remarkable defect.
	Mechanical		* Dimensions to conform to individual specification sheet.
2.	Capacitance	Cap≤1000pF, 1.0±0.2Vrms, 1MHz±10%	* Shall not exceed the limits given in the detailed spec.
3.	Q/ D.F.	Cap>1000pF, 1.0±0.2Vrms, 1KHz±10%	* NP0: Cap≥30pF, Q≥1000; Cap<30pF, Q≥400+20C
	(Dissipation	At 25℃ ambient temperature.	
	Factor)		
4.	Dielectric	* To apply voltage: ( ≤100V ) 250% of rated voltage.	* No evidence of damage or flash over during test.
	Strength	* Duration: 1 to 5 sec.	
		* Charge and discharge current less than 50mA.	
		* To apply voltage:	
		200V~300V ≥2 times VDC	
		500V~999V ≥1.5 times VDC	
		* Cut-off, set at 10mA	
		* TEST= 15 sec.	
		* RAMP=0	
5.	Insulation	Rated voltage:<200V	≥10GΩ
	Resistance	To apply rated voltage for max. 120 sec.	
		Rated voltage:200~630V	≥10GΩ or RxC≥100Ω-F whichever is smaller
		To apply rated voltage (500V max.) for 60 sec.	\$ SX
6.	Temperature	With no electrical load.	* Capacitance change: within ±30ppm/℃
	Coefficient	Operating temperature: -55~125℃ at 25℃	7 (S) T
7.	Adhesive	* Pressurizing force :	* No remarkable damage or removal of the terminations.
	Strength of	2N (0201) and 5N (≤0603) and 10N (>0603)	Y
	Termination	* Test time: 10±1 sec.	
8.	Vibration	* Vibration frequency: 10~55 Hz/min.	* No remarkable damage.
	Resistance	* Total amplitude: 1.5mm	* Cap change and Q/D.F.: To meet initial spec.
		* Test time: 6 hrs. (Two hrs each in three mutually	· 2 🗟
		perpendicular directions.)	
		* Cap./DF(Q) Measurement to be made after de-aging at	0 5
		150℃ for 1hr then set for 24±2 hrs at room temp.	1000
9.	Solderability	* Solder temperature: 235±5°C	95% min, coverage of all metalized area.
		* Dipping time: 2±0.5 sec.	IIII.
10.	Bending Test	* The middle part of substrate shall be pressurized by means	* No remarkable damage.
		of the pressurizing rod at a rate of about 1 mm per second until	* Cap change: within ±5.0% or ±0.5pF whichever is larger.
		the deflection becomes 1 mm and then the pressure shall be	(This capacitance change means the change of capacitance under
		maintained for 5±1 sec.	specified flexure of substrate from the capacitance measured before
		* Measurement to be made after keeping at room temp. for	the test.)
		24±2 hrs.	
11.	Resistance to	* Solder temperature: 260±5℃	* No remarkable damage.
	Soldering Heat	* Dipping time: 10±1 sec	* Cap change: within ±2.5% or ±0.25pF whichever is larger.
		* Preheating: 120 to 150℃ for 1 minute before imme rse the	* Q/D.F., I.R. and dielectric strength: To meet initial requirements.
		capacitor in a eutectic solder.	* 25% max. leaching on each edge.
		* Cap. / DF(Q) / I.R. Measurement to be made after de-aging	
		at 150℃ for 1hr then set for 24±2 hrs at room temp.	



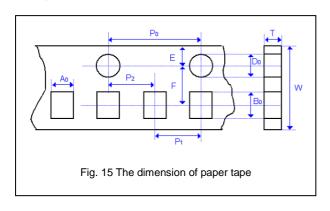
# **Multilayer Ceramic Capacitors**

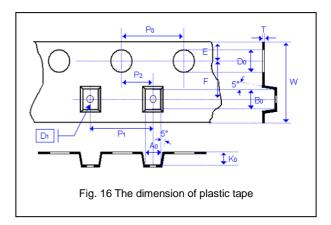
App	roval	Sheet

No.	Item		Test Condition	n		Requirements			
12.	Temperature	* Conduc	t the five cycles according to th	e temperatures	and	* No remarkable damage.			
	Cycle	time.				Cap change: within ±2.5% or ±0.25pF whichever is larger.			
		Step	Temp. (℃)	Time (min.)		* Q/D.F., I.R. and dielectric strength: To meet initial requirements.			
		1	Min. operating temp. +0/-3	30±3					
		2	Room temp.	2~3					
		3 4	Max. operating temp. +3/-0 Room temp.	30±3 2~3					
		:	PF(Q) / I.R. Measurement to be		aging				
		: '	for 1hr then set for 24±2 hrs at		291119				
13.	Humidity		np.: 40±2℃	·		* No remarkable damage.			
	(Damp Heat)	* Humidit	y: 90~95% RH			* Cap change: within ±5.0% or ±0.5pF whichever is larger.			
	Steady State	* Test tim	e: 500+24/-0hrs.			* Q/D.F. value:			
		* Cap. / C	OF(Q) / I.R. Measurement to be	made after de-a	aging	NP0: Cap≥30pF, Q≥350; 10pF≤Cap<30pF, Q≥275+2.5C			
		at 150℃	for 1hr then set for 24±2 hrs at	room temp.		Cap<10pF; Q≥200+10C			
						* I.R.: ≥1GΩor RxC≥50Ω-F whichever is smaller.			
14.	Humidity	* Test ten	np.: 40±2℃			* No remarkable damage.			
	(Damp Heat)	* Humidit	y: 90~95%RH			* Cap change: within ±7.5% or ±0.75pF whichever is larger.			
	Load	* Test tim	e: 500+24/-0 hrs.			* Q/D.F. value:			
		* To apply	y voltage: rated voltage (Max.	500V)		NP0: Cap≥30pF, Q≥200; Cap<30pF, Q≥100+10/3C			
		* Cap. / D	OF(Q) / I.R. Measurement to be	made after de-	aging	* I.R.: ≥500MΩ or RxC≥25Ω-F whichever is smaller.			
		at 150℃	for 1hr then set for 24±2 hrs a	t room temp.	1	3			
15.	High	* Test ten	np.:	ПЛ	//3	* No remarkable damage.			
	Temperature	NP0: 12	25±3℃	、货股门	分文	* Cap change: within ±3.0% or ±0.3pF whichever is larger.			
	Load	* To apply	y voltage:	X		* Q/D.F. value:			
	(Endurance)	(1) <500\	(1) <500V: 200% of rated voltage.			NP0: Cap≥30pF, Q≥350			
		(2) 500V:	150% of rated voltage.			10pF≤Cap<30pF, Q≥275+2.5C			
		(3) ≥630\	/: 120% of rated voltage.			Cap<10pF, Q≥200+10C			
			e: 1000+24/-0 hrs.	SSTVE SVETE		* I.R.: ≥1GΩ or RxC≥50Ω-F whichever is smaller.			
		* Cap. / D	PF(Q) / I.R. Measurement to be	made after de-	aging	s Q			
		at 150℃	for 1hr then set for 24±2 hrs at	room temp.					

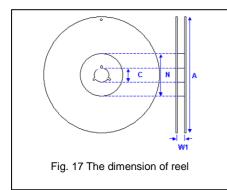
# **APPENDIXES**

# **■ Tape & reel dimensions**





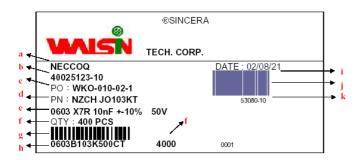
Size	0201	0402	0603		0805	
Thickness	L	N	S, X	Α	В	C, D, I
A <sub>0</sub>	0.40 +/-0.10	0.70 +/-0.20	1.05 +/-0.30	1.50 +/-0.20	1.50 +/-0.20	< 1.80
B <sub>0</sub>	0.70 +/-0.10	1.20 +/-0.20	1.80 +/-0.30	2.30 +/-0.20	2.30 +/-0.20	< 2.70
Т	≦0.55	≦0.80	≦1.20	≦1.15	≦1.20	0.23 +/-0.1
K <sub>0</sub>	-	/typ	- 7/	(E)	-	< 2.50
w	8.00 +/-0.30	8.00 +/-0.30	8.00 +/-0.30	8.00 +/-0.30	8.00 +/-0.30	8.00 +/-0.30
P <sub>0</sub>	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10
10xP <sub>0</sub>	40.00 +/-0.10	40.00 +/-0.10	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20
P <sub>1</sub>	2.00 +/-0.05	2.00 PASSIV +/-0.05	€ SYST€4.00 LLIANCE +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10
P <sub>2</sub>	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05
D <sub>0</sub>	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0
D <sub>1</sub>	-	Ch.			-	1.00 +/-0.10
Е	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10
F	3.50 +/-0.05	3.50	3.50	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05



Size	0201, 0402, 0603, 0805						
Reel size	7"	10"	13"				
С	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2				
$\mathbf{W}_1$	8.4+1.5/-0	8.4+1.5/-0	8.4+1.5/-0				
A 178.0±1.0		250.0±1.0	330.0±1.0				
N	60.0+1.0/-0	100.0±1.0	100±1.0				



### Example of customer label

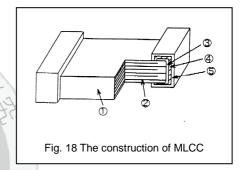


<sup>\*</sup>Customized label is available upon request

- a. Customer name
- b. WTC order series and item number
- c. Customer P/O
- d. Customer P/N
- e. Description of product
- f. Quantity
- g. Bar code including quantity & WTC P/N or customer
- h. WTC P/N
- i. Shipping date
- j. Order bar code including series and item numbers
- k. Serial number of label

#### Constructions

No.	Na	me	NP0
①	Ceramic	material	CaZrO₃ based
2	Inner el	ectrode	Ni (1)
3		Inner layer	Cu
4	Termination	Middle layer	Ni Ni
(5)		Outer layer	## Sn A D



PASSIVE SYSTEM ALLIANCE

### Storage and handling conditions

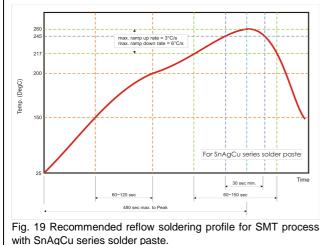
- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

#### Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.

# **■** Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of  $N_2$  within oven are recommended.



with SnAgCu series solder paste.

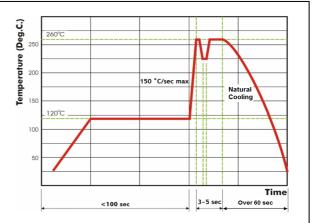


Fig. 20 Recommended wave soldering profile for SMT process with SnAgCu series solder.



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M39014/02-1025V M39014/22-0631 D55342E07B523DR-T/R NCA1206X7R103K50TRPF NCA1206X7R104K16TRPF NIN-FB391JTRF
NIN-FC2R7JTRF NMC0201X5R474K4TRPF NMC0402NPO220J50TRPF NMC0402X5R105K6.3TRPF NMC0402X5R224K6.3TRPF
NMC0402X7R103J25TRPF NMC0402X7R153K16TRPF NMC0603NPO1R8C50TRPF NMC0603NPO201J50TRPF
NMC0603NPO330G50TRPF NMC0603X5R475M6.3TRPF NMC0805NPO270J50TRPF NMC0805NPO820J50TRPF
NMC0805X7R224K16TRPLPF NMC0805X7R224K25TRPF NMC1206X7R102K50TRPF NMC1206X7R106K10TRPLPF
NMC1206X7R475K10TRPLPF NMC-H0805X7R472K250TRPF NMC-L0402NPO7R0C50TRPF NMC-L0603NPO2R2B50TRPF NMC-P0805NPO221J500TRPLPF NMC-Q0402NPO8R2D200TRPF C1206C101J1GAC C1608C0G2A221J C1608X7R1E334K C2012C0G2A472J
2220J2K00562KXT 1812J2K00332KXT CDR31BX103AKWR CDR33BX104AKUR CDR33BX683AKUS CGA2B2C0G1H010C
CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H391J
CGA2B2C0G1H181JT0Y0F CGA2B2C0G1H1R5C CGA2B2C0G1H12R2C CGA2B2C0G1H390J CGA2B2C0G1H391J